

July 2008 Power-SPM<sup>™</sup>

# FP7G50US60 Transfer Molded Type IGBT Module

## **General Description**

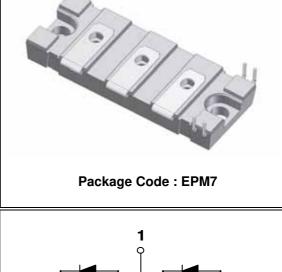
Fairchild's New IGBT Modules (Transfer Molded Type ) provide low conduction and switching losses as well as short circuit ruggedness. They are designed for applications such as Motor control, Uninterrupted Power Supplies (UPS) and general Inverters where short circuit ruggedness is a required feature.

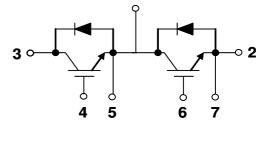
## Features

- Short Circuit rated 10us @Tc=100°C, Vge=15V
- High Speed Switching
- Low Saturation Voltage : Vce(sat) =2.2V @lc=50A
- High Input Impedance
- Fast & Soft Anti-Parallel FWD

### Application

- Welders
- AC & DC Motor Controls
- General Purpose Inverters
- Robotics
- Servo Controls
- UPS



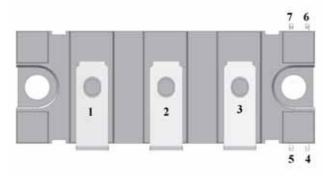


Internal Circuit Diagram

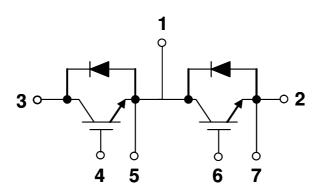
## **Absolute Maximum Ratings**

Symbol	Description		Rating	Units	
V <sub>CES</sub>	Collector-Emitter Voltage		600	V	
V <sub>GES</sub>	Gate-Emitter Voltage		± 20	V	
IC	Collector Current	@ T <sub>C</sub> = 25°C	50	A	
I <sub>CM (1)</sub>	Pulsed Collector Current		100	A	
I <sub>F</sub>	Diode Continuous Forward Current	@ T <sub>C</sub> = 100°C	50	A	
I <sub>FM</sub>	Diode Maximum Forward Current	-	100	A	
T <sub>SC</sub>	Short Circuit Withstand Time	@ T <sub>C</sub> = 100°C	10	us	
PD	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	250	W	
TJ	Operating Junction Temperature	-	-40 to +125	°C	
T <sub>stg</sub>	Storage Temperature Range		-40 to +125	°C	
V <sub>iso</sub>	Isolation Voltage	@ AC 1minute	2500	V	
Mounting	Power Terminals Screw : M5		2.0	N.m	
Torque	Mounting Screw : M5		2.0	N.m	

## Pin Configuration and Pin Description



**Top View** 



Internal Circuit Diagram

### **Pin Description**

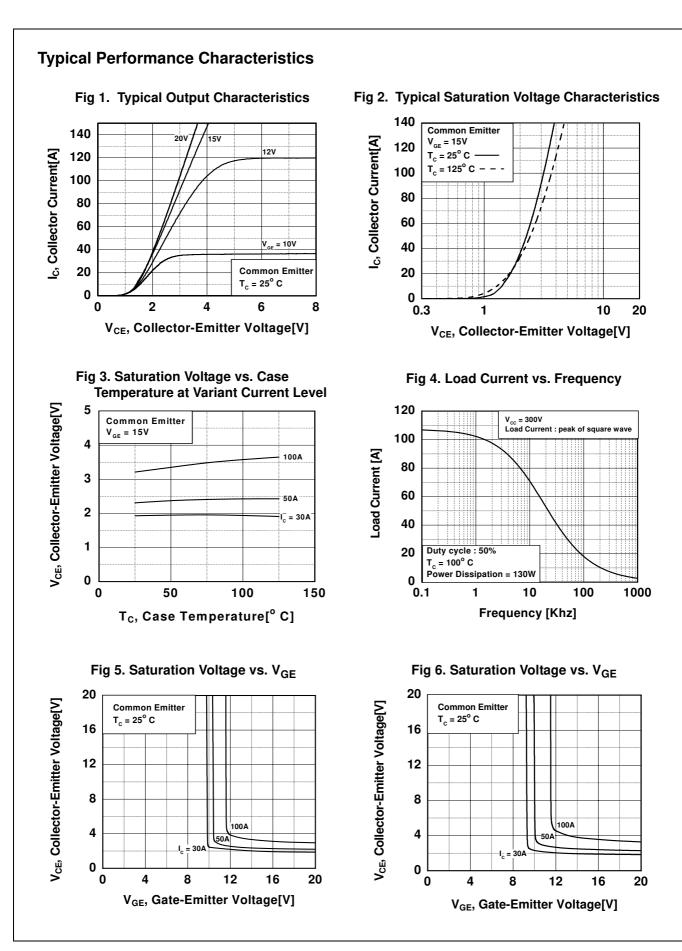
Pin Number	Pin Description
1	Emitter of Q1, IGBT, Collector of Q2, IGBT
2	Emitter of Q2, IGBT
3	Collector of Q1, IGBT
4	Gate of Q1, IGBT
5	Emitter of Q1, IGBT
6	Gate of Q2, IGBT
7	Emitter of Q2, IGBT

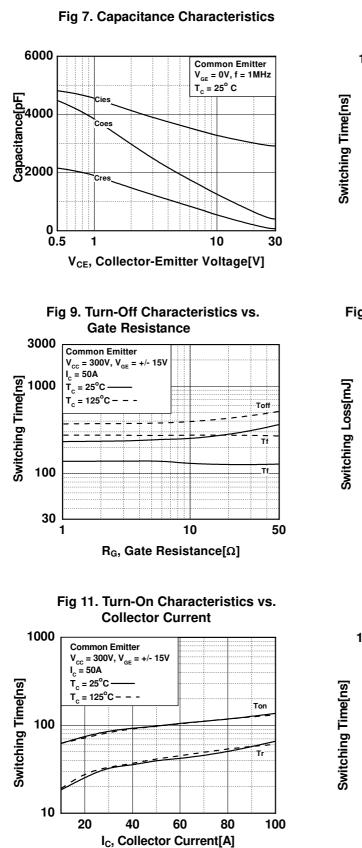
Symbol	Parameter	Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV <sub>CES</sub>	Collector-Emitter Breakdown Voltage	$V_{GE} = 0V, I_{C} = 250 \mu A$	600	-	-	V
$\Delta BV_{CES}/\Delta T_J$	Temperature Coeff. of Breakdown Voltage	V <sub>GE</sub> = 0V, I <sub>C</sub> = 1mA	-	0.6	-	V
I <sub>CES</sub>	Collector Cut-off Current	$V_{CE} = V_{CES}, V_{GE} = 0V$	-	-	250	uA
I <sub>GES</sub>	Gate-Emitter Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0V$	-	-	± 100	nA
On Char	acteristics					
V <sub>GE(th)</sub>	G-E Threshold Voltage	$V_{GE} = 0V, I_C = 50mA$	5.0	6.0	8.5	V
V <sub>CE(sat)</sub>	Collector to Emitter Saturation Voltage	I <sub>C</sub> = 50A, V <sub>GE</sub> = 15V	-	2.2	2.8	V
Dvnamic	Characteristics					
C <sub>ies</sub>	Input Capacitance			2920		pF
C <sub>oes</sub>	Output Capacitance	V <sub>CE</sub> = 30V, V <sub>GE</sub> = 0V, f = 1MHz		400		pF
C <sub>res</sub>	Reverse Capacitance			75		pF
t <sub>d(on)</sub> t <sub>r</sub>	Turn-On Delay Time Rise Time	-	-	58 40	-	ns ns
	g Characteristics					
		$V_{CC} = 300 \text{ V}, \text{ I}_{C} = 50\text{A},$ $R_{G} = 5.9\Omega, V_{GE} = 15\text{ V}$ Inductive Load, $T_{C} = 25^{\circ}\text{C}$	-	107	-	
t <sub>d(off)</sub>	Turn-Off Delay Time Fall Time		-	140	-	ns
t <sub>f</sub> E <sub>on</sub>	Turn-On Switching Loss		-	0.75	-	ns mJ
E <sub>off</sub>	Turn-Off Switching Loss	-	-	0.73	-	mJ
E <sub>ts</sub>	Total Switching Loss	-	_	1.29	_	mJ
t <sub>d(on)</sub>	Turn-On Delay Time		-	53	-	ns
t <sub>r</sub>	Rise Time	-	-	40	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	-	-	106	-	ns
t <sub>f</sub>	Fall Time	- V <sub>CC</sub> = 300 V, I <sub>C</sub> = 50A, R <sub>G</sub> = 5.9Ω, V <sub>GE</sub> = 15V	-	274	-	ns
E <sub>on</sub>	Turn-On Switching Loss	Inductive Load, $T_C = 125^{\circ}C$	-	1.09	-	mJ
E <sub>off</sub>	Turn-Off Switching Loss		-	1.68	-	mJ
E <sub>ts</sub>	Total Switching Loss		-	2.77	-	mJ
T <sub>sc</sub>	Short Circuit Withstand Time	V <sub>CC</sub> = 300 V, V <sub>GE</sub> = 15V @ T <sub>C</sub> = 100°C	10	-	-	us
Qg	Total Gate Charge		-	136	-	nC
Q <sub>ge</sub>	Gate-Emitter Charge	V <sub>CE</sub> = 300 V, I <sub>C</sub> = 50A, V <sub>GE</sub> = 15V	-	26	-	nC
Q <sub>gc</sub>	Gate-Collector Charge		1	76	1	nC

Symbol	Parameter	Con	ditions	Min	Тур	Max	Units
V <sub>FM</sub> Diode Forward Voltage	5		$T_{C} = 25^{\circ}C$	-	- 1.9 2.8	2.8	v
	Diode Forward voltage	I <sub>F</sub> = 50A	$T_{C} = 100^{\circ}C$	-	1.8	-	
Diada Davarra Daaavarra Tiraa			$T_{\rm C} = 25^{\circ}{\rm C}$	-	76	100	
t <sub>rr</sub>	Diode Reverse Recovery Time	 I <sub>F</sub> = 50A	$T_{C} = 100^{\circ}C$	-	138		ns
1	Diada Daali Davana Daaawan Oumant		$T_{C} = 25^{\circ}C$	-	4	5.2	
rr Diode Peak Reverse Recovery Curre		di / dt = 100 A/us	$T_{C} = 100^{\circ}C$	-	6		A
<u> </u>			$T_{C} = 25^{\circ}C$	-	152	260	
Q <sub>rr</sub>	Diode Reverse Recovery Charge		T <sub>C</sub> = 100°C	-	404		nC

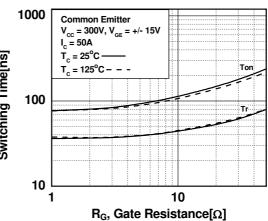
## **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units
$R_{ ext{ heta}JC}$	Junction-to-Case (IGBT Part, per 1/2 Module)	-	0.4	°C/W
$R_{ ext{ heta}JC}$	Junction-to-Case (DIODE Part, per 1/2 Module)	-	1.0	°C/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.05	-	°C/W
Weight	Weight of Module	-	90	g

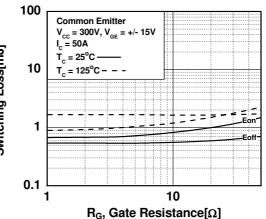


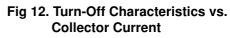


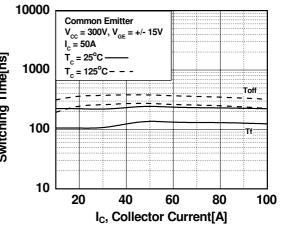
### Fig 8. Turn-On Characteristics vs. Gate Resistance

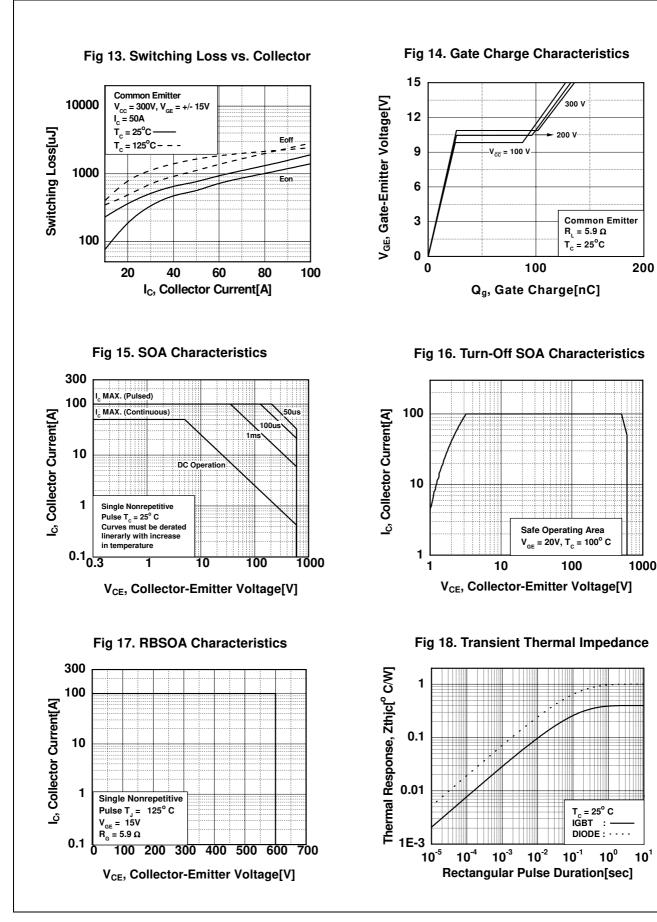


### Fig 10. Switching Loss vs. Gate Resistance









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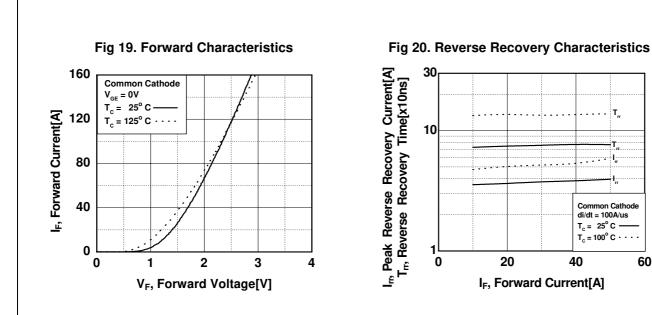
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Common Cathode di/dt = 100A/us

60

 $T_{c} = 25^{\circ} C T_c = 100^\circ C \cdot \cdot \cdot$ 

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### FP7G50US60 Rev. A

FP7G50US60 Transfer Molded Type IGBT Module 14.50<sup>+0.50</sup> (5°) (R. 65) 9.60±0.10 12.20±0.30

18.40±0.50

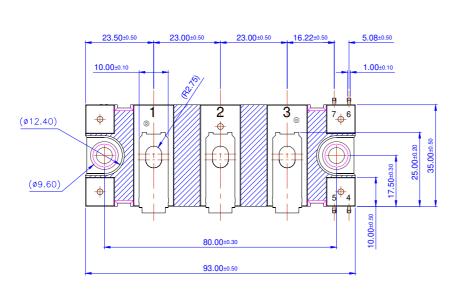
 $0.80_{-0.05}^{+0.10}$ 

**38.80**±1.00

(14°) (14°)

(R1.00)

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